900V 9A 0.88Ω N-ch Power MOSFET

Description

DT2 MOS is DIN-TEK 2nd generation VDMOS family that is dramatic reduction in on-resistance and ultra-low gate charge for applications requiring high power density and high efficiency. And it is very robust and RoHS compliant.

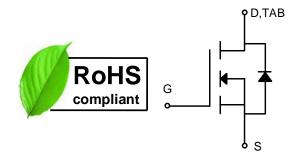


Features

- Typ.R_{DS(on)}=0.88 Ω @V_{GS}=10V
- 100% avalanche tested
- RoHS Compliant

Applications

- SMPS
- Charger
- DC-DC



Absolute Maximum Ratings (T_C=25°C)

Parameter	Symbol	DTN9N90/DTR9N90	DTP9N90F	DTP9N90	Unit
Drain-source voltage	V _{DSS}	900			V
Gate-source voltage	V _G S		±30		V
Continuous drain current	ID		9		А
Pulsed drain current ¹	I _{DM}		36		Α
Avalanche energy, single pulse ²	Eas	245			mJ
Power dissipation	P _D	250	62.5	167	W
Derate above 25°C		2	0.5	1.3	W/°C
Operating junction temperature	Tj		-55~150		°C
Storage temperature	T _{stg}		-55~150		℃
Continuous diode forward current	Is	9			
Diode pulse current	I _{Spulse} ¹	36			Α
Thermal resistance,junction-to-case	Rejc	0.5	2	0.75	°C/W
Thermal resistance,junction-to-ambient	RθJA	50	62.5	62.5	°C/W



DTN9N90 DTP9N90F DTP9N90 DTR9N90

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Electrical Characteristics of MOSFET

Parameter	Symbol	Test Condition		Min.	Тур.	Max.	Unit
Drain-source break down voltage	BV _{DSS}	I _D =250μA, V _{GS} =0V	Tc=25°C	900	-	-	V
Gate threshold voltage	V _{GS(th)}	I _D =250μA, V _{DS} =V _{GS}	TJ=25°C	2.5	-	4.5	V
Drain-source leakage current		V _{DS} =900V, V _{GS} =0V	TJ=25°C	-	-	1	μA
	IDSS	V _{DS} =720V, V _{GS} =0V	TJ=125°C	-	-	100	μA
Gate-source leakage current,forward	IGSSF	V _{DS} =0V, V _{GS} =30V	TJ=25°C	-	-	100	nA
Gate-source leakage current,reverse	Igssr	V _{DS} =0V, V _{GS} =-30V	TJ=25°C	-	-	-100	nA
Drain-source on-state resistance ³	R _{DS(ON)}	V _{GS} =10V, I _D =4.5A	TJ=25°C	-	0.88	1.1	Ω
Transconductance ³	Gfs	V _{DS} =10V	TJ=25°C	-	10	-	S

Dynamic Characteristics of MOSFET (Tc=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Input capacitance	C _{iss}		-	2843	-	pF
Output capacitance	Coss	f=1MHz, V _{DS} =25V, V _{GS} =0V	-	212	-	pF
Reverse transfer capacitance	Crss		-	17	-	pF
Gate to source charge	Q _{gs}	V _{DD} =450V	-	16.5	-	nC
78Gate to drain charge	Q_{gd}	I _D =9A	-	20.1	-	nC
Total gate charge	Qg	V _{GS} = 0 to 10V	-	58.5	-	nC

Switching Characteristics of MOSFET (Tc=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Turn-on delay time	t _{d on}		-	48	-	ns
Rise time	tr	V _{DS} =450V, I _D =9A,	-	38	-	ns
Turn-off delay time	t _{d off}	R _G =25Ω, V _{GS} =0 to 10V	-	158	-	ns
Fall time	tf		-	40	-	ns

Characteristics of Body Diode (Tc=25℃)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward voltage	V _{SD}	I _{SD} =9A, V _{GS} =0V	-	-	1.4	V
Reverse recovery time	t _{rr}	Vps=450V, Is=9A, Vgs=10V	-	544	-	ns
Reverse recovery current	Irr		-	18	-	Α
Recovery charge	Qrr	-di/dt=100A/μs	-	5	-	μC

Notes:

- 1. Repetitive rating, pulse width limited by junction temperature $T_{\text{J}(\text{MAX})}$ =150°C.
- 2. The E_{AS} data shows Max. rating . The test condition is V_{DD} =50V, V_{GS} =10V, L=10mH, I_{AS} =7A,Tc=25°C.
- 3. The data tested by pulsed , pulse width $\leq 300 \mu s$, duty cycle $\leq 2\%$.

TYPICAL CHARACTERISTICS

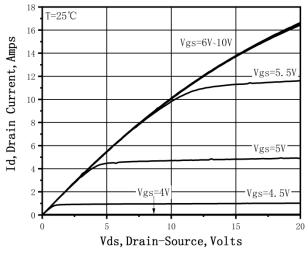


Figure 1.On-Region Characteristics

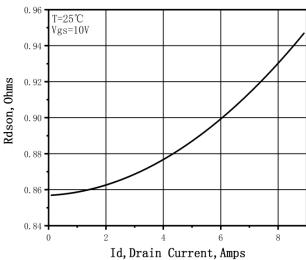


Figure 3.Static Drain-Source On Resistance

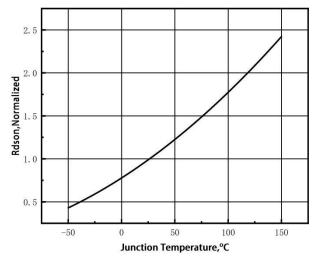


Figure 5. Normalized R_{DS(on)} vs.Temperature

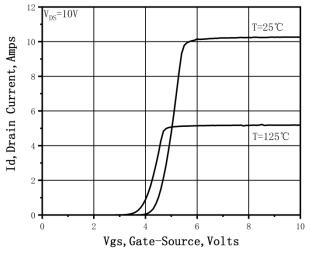


Figure 2. Transfer Characteristics

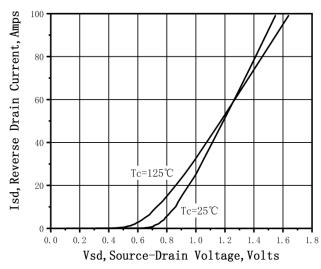


Figure 4. Typical Body Diode Transfer Characteristics

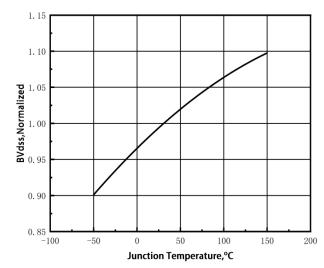
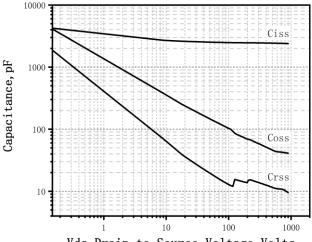


Figure 6. Normalized BV_{DSS} vs.Temperature





Vds, Drain to Source Voltage, Volts Figure 7. Capacitance Characteristics

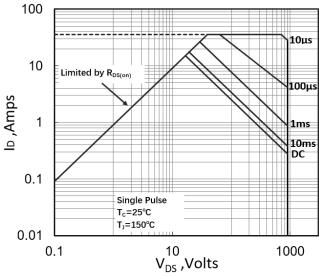


Figure 9. Maximum Safe Operating Area (TO-247/TO-3P)

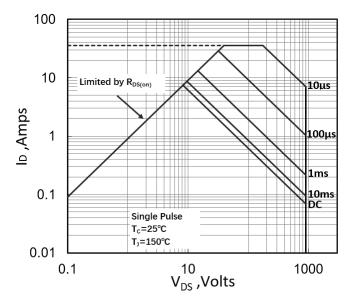


Figure 11. Maximum Safe Operating Area (TO-220F)

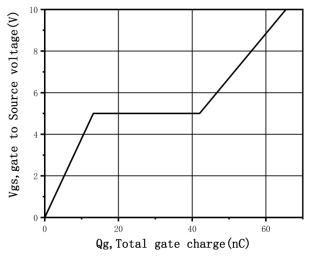


Figure 8. Gate Charge Characteristics

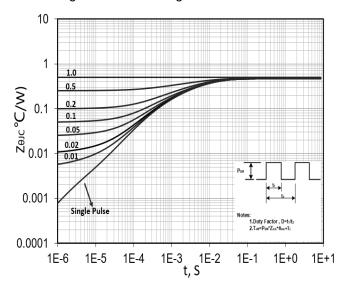


Figure 10. Transient Thermal Response Curve (TO-247/TO-3P)

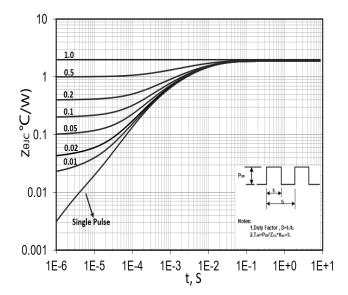


Figure 12. Transient Thermal Response Curve (TO-220F)





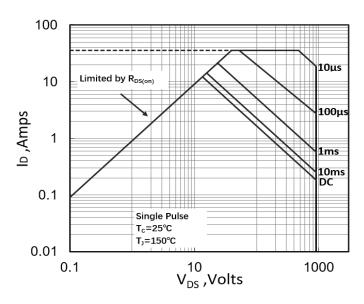


Figure 13. Maximum Safe Operating Area (TO-220)

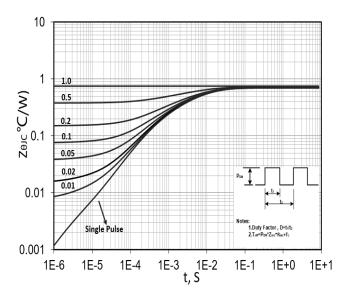
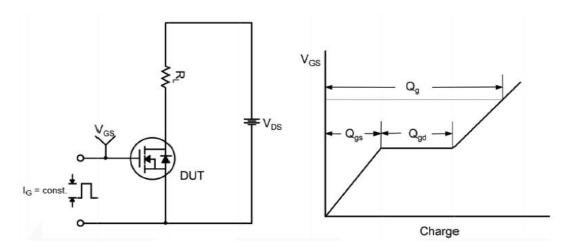


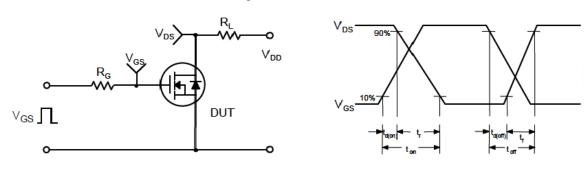
Figure 14. Transient Thermal Response Curve (TO-220)

Test Circuit

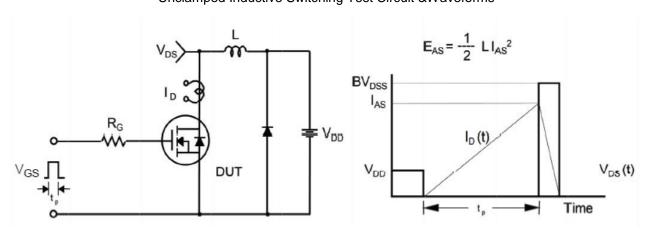
Gate Charge Test Circuit &Waveform



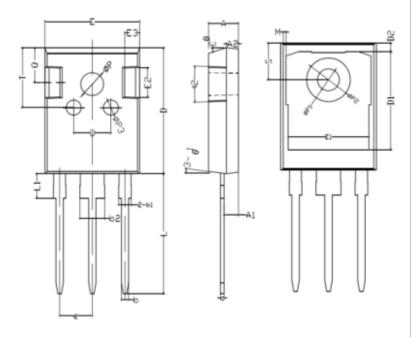
Switching Test Circuit &Waveforms



Unclamped Inductive Switching Test Circuit &Waveforms



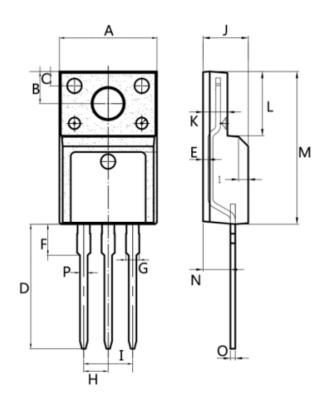
Mechanical Dimensions for TO-247



COMMON DIMENSIONS

SYMBOL	M	М
STIVIDOL	MIN	MAX
Α	4.80	5.20
A1	2.21	2.59
A2	1.85	2.15
b	1.11	1.36
b1	1.91	2.25
b2	2.91	3.25
С	0.51	0.75
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.00	13.60
E2	4.80	5.20
E3	2.30	2.70
е	5.40	5.48
L	19.62	20.22
L1	-	4.30
ØР	3.40	3.80
ØP2	6.90	7.30
S	6.05	6.25

Mechanical Dimensions for TO-220F

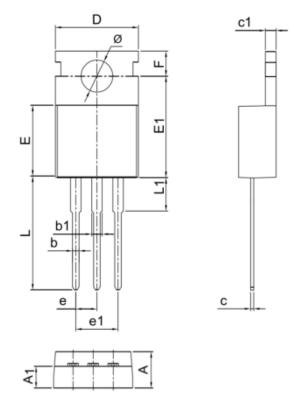


COMMON DIMENSIONS

SYMBOL	M	М
STIVIDOL	MIN	MAX
Α	9.95	10.36
В	2.95	3.55
С	1.25	1.6
D	12.64	13.5
Е	0.40	0.60
F	2.80	3.80
G	1.14	1.58
Н	2.44	2.64
1	4.88	5.26
J	4.50	4.90
K	2.34	2.80
L	6.48	6.90
M	15.40	16.07
N	2.66	3.50
0	0.40	0.64
Р	0.70	0.94



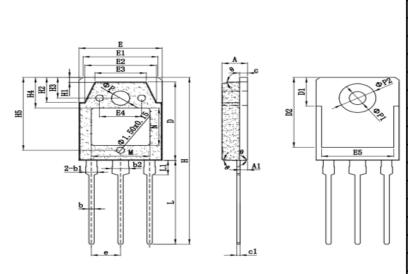
Mechanical Dimensions for TO-220



COMMON DIMENSIONS

SYMBOL	MM			
STIMBUL	MIN	MAX		
Α	4.30	4.70		
A1	2.30	2.82		
b	0.70	0.94		
b1	1.17	1.41		
С	0.30	0.64		
c1	1.17	1.44		
D	9.70	10.20		
Е	8.50	9.30		
E1	12.00	12.50		
е	2.44	2.64		
e1	4.88	5.26		
F	2.60	2.94		
L	13.00	14.00		
L1	3.385	4.20		
Ø	3.74	3.95		

Mechanical Dimensions for TO-3P



COMMON DIMENSIONS

SYMBOL	М	M
STIVIBUL	MIN	MAX
Α	4.65	4.95
A1	1.40	1.60
р	0.80	1.20
b1	1.90	2.30
b2	2.90	3.30
С	1.45	1.55
c1	0.5	0.65
D	17.70	19.70
D1	6.70	7.10
D2	16.60	17.00
Е	15.45	15.75
Н	39.80	40.20
لــ	19.70	20.30
L1	3.40	3.70
М	10.85	11.15
Z	8.70	9.10
е	5.40	5.48
ΦР	3.25	3.55
ФР1	3.00	3.30
ΦΡ2	6.70	7.10



Ordering Information

Part	Package	Marking	Packing method	Minimum packing number
DTN9N90	TO-247	DTN9N90	Tube	30 / Tube
DTP9N90F	TO-220F	DTP9N90F	Tube	50 / Tube
DTP9N90	TO-220	DTP9N90	Tube	50 / Tube
DTR9N90	TO-3P	DTR9N90	Tube	30 / Tube



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